U.S. PTO 273 009

| FORM PTO-1595 | RECORDATION FOR |
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|               | 05/05/2         |
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1. Name of conveying parties:

1.) Jin Gu KIM

4.) Seung Wook PARK

2.) Young Do KWEON

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2. Name and Address of receiving party:

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|            | Republic of KOREA<br>(postal code: 443-743)  |  |
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| 3.         | Nature of conveyance:  X   |  |
| <b>4</b> . | Application number(s) or patent number(s):  This document is being filed together with a new application.  OR  This document is being filed after filing of the application:  (a) Patent Application No(s)., filed; or  (b) Patent No(s)., issued. |  |
| 5.         | Name and address of party to whom correspondence concerning document should be mailed: STAAS & HALSEY LLP Our Docket: 1952.1089 Attention: David M. Pitcher 1201 New York Ave., N.W., Suite 700 Washington, D.C. 20005                             |  |
| <b>6</b> . | Total number of applications and patents involved:1  |  |
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**PATENT** REEL: 022686 FRAME: 0802

Docket No.

## **U.S. ASSIGNMENT**

|   | and of other good and valuable consideration paid to the undersigned   |
|---|--|
| inventor(s) (hereinafter, "ASSIGNOR") by (Insert Name(s) & Address(es) of ASSIGNEE(S))  |  |
| SAMSUNG Electro-Mechanics Co., Ltd.   |  |
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| (hereinafter, "ASSIGNEE"), the receipt of which is hereby ackn<br>ASSIGNEE the entire and exclusive right, title and interest to th<br>(Title of Invention)   | owledged, the undersigned ASSIGNOR hereby sells, assigns and transfers to c invention entitled   |
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| relating to International Patent Application PCT// executed on even date herewith or, if not so executed, was:  | and/or for which application for Letters Patent of the United States was   |
| (a) executed on;  | (Insert date of execution of application, if not concurrent)   |
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| Serial No;  | N.W., Suite 700, Washington, D.C. 20005 (202/434-1500) is hereby authorized to insert in (b) the specified data, when known.   |
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| reissue or reexamination application based thereon, for the full to any extensions thereof (collectively, hereinafter, "said application.  The ASSIGNOR agree(s), when requested by said ASSIGNE which the ASSIGNEE may deem necessary, desirable or expedincluding in the preparation and prosecution of said application (reexamination, or public use proceeding, and in any litigation or | E and without charge to but at the expense of said ASSIGNEE, to do all acts ent, for securing, maintaining and enforcing protection for said invention, s) and the issuance of said Letters Patent(s), in any interference, reissue, other legal proceeding which may arise or be declared in relation to same, such |
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| IN WITNESS WHEREOF, the undersigned inventor(s) has ( (Typed Name & Signature of Inventor(s))   | have) affixed his/her/their signature(s). (Date) (Typed Name & Signature of Witness(es))   |
|   |  |
| KIM Jin Gu  | 6. 4. 2009   |
| EXEON Young Do f  | Feb 4, 2009  |
| JEON HYUNG JIN JEON Hyung Jin   | Teb. 1.2009  |

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